



**Schneider Electric (Hong Kong) Ltd.**

**Application for Schneider Electric Scholarship Scheme 2011**

**NOTE TO APPLICANTS**

1. The information provided herein will be used for purposes related to the Schneider Electric Scholarship Scheme 2011. It may be made available to any person who process scholarship matters. Personal data provided by applicants will be treated strictly confidential.
  
2. Applicants must submit the application form together with the below documents on or before 31 May 2011 to [hk-sehkmkt@hk.schneider-electric.com](mailto:hk-sehkmkt@hk.schneider-electric.com) OR Schneider Electric (Hong Kong) Ltd., 13/F, East Wing, Warwick House, Taikoo Place, 979 King's Road, Quarry Bay, Hong Kong:
  - a. 2 recommendations letters
  - b. Copies of academic transcripts and awards in the previous academic years
  - c. Proof of HK/Macau permanent resident (e.g. copy of identity card)

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**Personal Particulars**

Name \*Mr/Mrs/Ms/Miss \_\_\_\_\_  
(Last name) (First name)

Name in Chinese \_\_\_\_\_

Nationality \_\_\_\_\_ Date of Birth \_\_\_\_\_

Correspondence Address \_\_\_\_\_

Email Address \_\_\_\_\_ Contact No. \_\_\_\_\_



**Academic Record**

(Please list in chronological order and submit copies of related certificates and transcripts)

Institutions	Level attained/results	Period		Full-time/ Part-time	Degree/Diploma awarded
		From	To		

**Scholarships / Prizes / Awards Received**

Date Attained	Scholarships / Prizes /Awards	Issued by

**Working Experience**

Company	Position Held	Period		Full-time/ Part-time	Major Responsibilities
		From	To		



**Extra-curricular Participation**

Positions held, voluntary work and extra-curricular activities during the past two years.

**Other Relevant Information**

Any other information which you consider relevant to this application.

**Personal Statement**

In not more than 500 words, please explain your educational plans and career goals in the next 5 years.

CONFIDENTIAL



**Declaration**

I certify that the information given in support of this application is accurate and complete. I understand that any misrepresentation will disqualify my application.

Date: \_\_\_\_\_ Signature : \_\_\_\_\_